



Spec No.: DS20-2011-0052 Effective Date: 05/22/2012

Revision: A

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

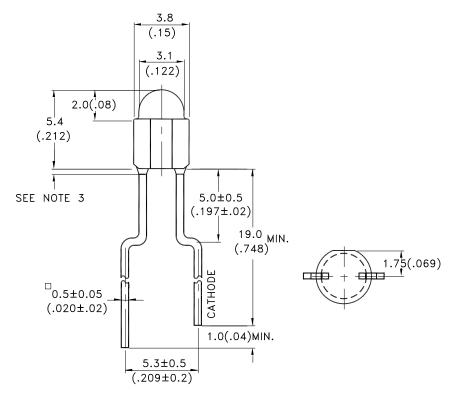
LITEON LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

Features

- * Lead (Pb) free product RoHS compliant.
- * High luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Versatile mounting on P.C. Board or panel.
- * I.C. Compatible/low current requirement.
- * Popular T-1 diameter package.

Dimensions Package



Part No.	Lens	Source Color
LTL17KCBH5D-0G1A	Blue Diffused	InGaN Blue

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm(.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

Part No.: LTL17KCBH5D-0G1A (FOR HITACHI ONLY)	Page:	1	of	10	
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Absolute Maximum Ratings at TA=25°C

Parameter	Maximum Rating	Unit		
Power Dissipation	108	mW		
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA		
Continuous Forward Current	30	mA		
Derating Linear From 30°C	0.5	mA/°C		
Operating Temperature Range	-30°C to + 80°C			
Storage Temperature Range	-40°C to + 100°C			
Lead Soldering Temperature [1.6 mm(.063") From Body]	260°C for 5 Seconds Max.			

Part No.: LTL17KCBH5D-0G1A (FOR HITACHI ONLY) Page: 2 of 10

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Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	310	-	880	mcd	I _F = 20mA Note 1
Viewing Angle	2 heta 1/2	-	50	-	deg	Note 2 (Fig.6)
Peak Emission Wavelength	λР	ı	468	ı	nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd	460	470	475	nm	Note 4
Spectral Line Half-Width	Δλ	-	22	-	nm	
Forward Voltage	V_{F}	2.7	3.2	3.6	V	$I_F = 20 \text{mA}$
Reverse Current	IR	-	-	10	μ A	$V_R = 5V$

NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Iv classification code is marked on each packing bag.
- 4. The dominant wavelength, λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 5. Reverse voltage (V_R) condition is applied for IR test only. The device is not designed for reverse operation.

Part No.: LTL17KCBH5D-0G1A (FOR HITACHI ONLY)	Page :	3	of	10	
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Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

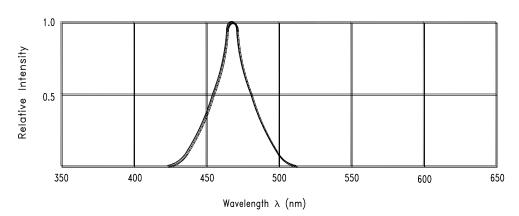
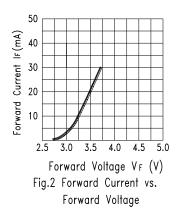
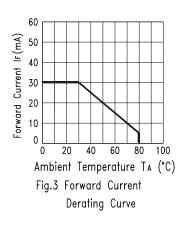


Fig.1 Relative Intensity vs. Wavelength





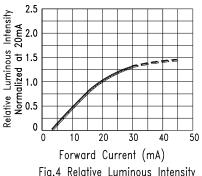


Fig.4 Relative Luminous Intensity vs. Forward Current

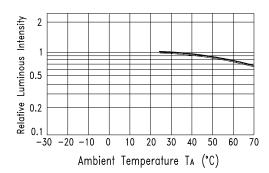


Fig.5 Luminous Intensity vs. Ambient Temperature

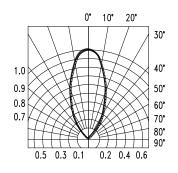


Fig.6 Spatial Distribution

Part No.: LTL17KCBH5D-0G1A (FOR HITACHI ONLY) 10

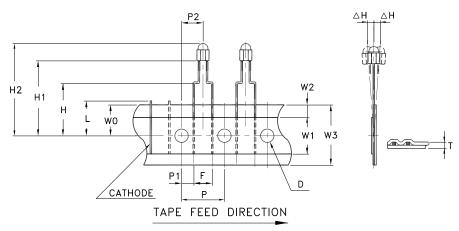
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Features

- * Compatible with radial lead automatic insertion equipment.
- * Most radial lead plastic lead lamps available packaged in tape and folding.
- * 5mm (0.197") formed lead spacing available.
- * Folding packaging simplifies handling and testing. Reel packaging is available by removing suffix "A" on option.

Package Dimensions



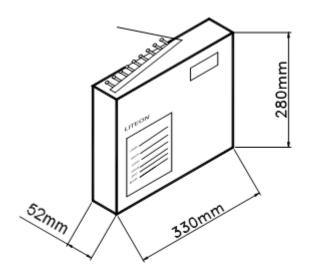
		Specification					
Item	Symbol	Mini	mum	Maximum			
		mm	inch	mm	inch		
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165		
Component Lead Pitch	F	4.8	0.188	5.8	0.228		
Front to Rear Deflection	ΔΗ			2.0	0.078		
Height of Seating Plane	Н	15.5	15.5 0.610		0.649		
Feed Hole to Bottom of Component	H1	20.0	0.787	22.0	0.866		
Feed Hole to Overall Component Height	H2	25.1	0.988	27.7	1.091		
Lead Length After Component Height	L	W0		11.0	0.433		
Feed Hole Pitch	P	12.4	12.4 0.488		0.511		
Lead Location	P1	3.15	0.124	4.55	0.179		
Center of Component Location	P2	5.05	0.198	7.65	0.301		
Total Taped Thickness	T			0.90	0.035		
Feed Hole Location	W0	8.5	0.334	9.75	0.384		
Adhesive Tape Width	W1	14.5	0.571	15.5	0.610		
Adhesive Tape Position	W2	0	0	3.0	0.118		
Tape Width	W3	17.5	0.689	19.0	0.748		

5 of Page: 10 Part No.: LTL17KCBH5D-0G1A (FOR HITACHI ONLY)

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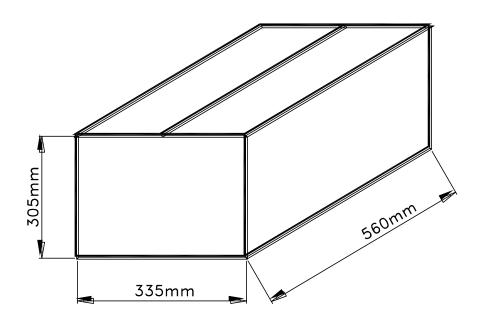
Packing Spec

3,000 pcs per inner carton



Tolerance: ±5mm

10 Inner cartons per outer carton, total 30,000 pcs per outer carton In every shipping lot, only the last pack will be non-full packing



Part No.: LTL17KCBH5D-0G1A (FOR HITACHI ONLY)

Page:

of

6

10



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Bin Table Specification

Luminous Inte	ensity Unit	: mcd @20mA
Bin Code	Min.	Max.
KL	310	520
MN	520	880

Note: Tolerance of each bin limit is $\pm 15\%$

Dominant Wavelength		t : nm @20mA
Bin Code	Min.	Max.
B07	460.0	465.0
B08	465.0	470.0
B09	470.0	475.0

Note: Tolerance of each bin limit is ± 1 nm

Page: of 10 Part No.: LTL17KCBH5D-0G1A (FOR HITACHI ONLY)



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CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity.

It is recommended that LEDs out of their original packaging are used within three months.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 1.6mm from the base of LED lens.

Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, For Lamp without stopper type and must be leave a minimum of 1.6mm clearance from the base of the lens to the soldering point.

To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering iron		Wave soldering		
Temperature Soldering time	400°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	120°C Max. 60 sec. Max. 260°C Max. 5 sec. Max.	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED

Part No.: LTL17KCBH5D-0G1A (FOR HITACHI ONLY)	Page:	8	of	10	
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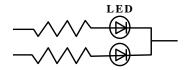
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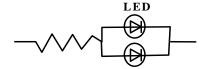
6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A







- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

ESD-damaged Leeds will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light up" at low currents. To verify for ESD damage, check for "light up" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

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Suggested checking list:

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DSL?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

8. Others

The appearance d specifications of the product may be modified for improvement, without prior notice.

Part No.: LTL17KCBH5D-0G1A (FOR HITACHI ONLY)	Page:	10	of	10	
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